

SID

Factory: Rot am See

Article:

689

ML10

Provided:

Stockburger, Olesja

Customer:

Date:

26.01.2016



Processtechnology: B: undefiniert

Material Text	Mat. Nr.	µm	Stackup	Process overview
A-RS Kupferfolie-035my 330x490mm	50200242	35	VS	 B00
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	195		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L2	
C-RS-FR4-ML-0.10mm-070+070-TG150-HF	50200773	100		
		70	L3	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L4	
C-RS-FR4-ML-0.10mm-070+070-TG150-HF	50200773	100		
		70	L5	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L6	
C-RS-FR4-ML-0.10mm-070+070-TG150-HF	50200773	100		
		70	L7	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	160		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
		70	L8	
C-RS-FR4-ML-0.10mm-070+070-TG150-HF	50200773	100		
		70	L9	
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	195		
A-RS-FR4-Prepreg-2116-TG150-HF	50200642	0		
A-RS Kupferfolie-035my 330x490mm	50200242	35	RS	

Thickness after Pressing

B00:

1890 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2090 µm

Dmin:

1690 µm

Thickness over all

0 µm

Tol+:

0 µm

Tol-:

0 µm

Dmax:

0 µm

Dmin:

0 µm

Demand for customer

Thickness (D):

2000 µm

Tol+:

200 µm

Tol-:

200 µm

Dmax:

2200 µm

Dmin:

1800 µm

Measuring point: (05) über LM und galv.Cu; beidseitig

nominal:

1900 µm

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